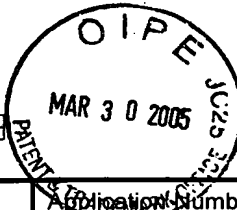


Please type a plus sign (+) inside this box →



HDP/SB/21 based on PTO/SB/21 (08-00)

JPW

# TRANSMITTAL FORM

(to be used for all correspondence after initial filing)

Application Number	2557-000153/US
Filing Date	July 3, 2003
Inventor(s)	Ja-Hum KU et al.
Group Art Unit	2829
Examiner Name	Evan T. Pert
Attorney Docket Number	2557-000153/US

## ENCLOSURES (check all that apply)

☐ Fee Transmittal Form

☐ Fee Attached

☐ Amendment

☐ After Final

☐ Affidavits/declaration(s)

☐ Extension of Time Request

☐ Express Abandonment Request

☐ Information Disclosure Statement

☐ Certified Copy of Priority Document(s)

☐ Response to Missing Parts/ Incomplete Application

☐ Response to Missing Parts under 37 CFR 1.52 or 1.53

☐ Assignment Papers (for an Application)

☐ Letter to the Official Draftsperson and \_\_\_\_\_ Sheets of Formal Drawing(s)

☐ Licensing-related Papers

☐ Petition

☐ Petition to Convert to a Provisional Application

☐ Power of Attorney, Revocation Change of Correspondence Address

☐ Terminal Disclaimer

☐ Request for Refund

☐ CD, Number of CD(s) \_\_\_\_\_

☐ After Allowance Communication to Group

☐ LETTER SUBMITTING APPEAL BRIEF AND APPEAL BRIEF (w/clean version of pending claims)

☐ Appeal Communication to Group (Notice of Appeal, Brief, Reply Brief)

☐ Proprietary Information

☐ Status Letter

☒ Other Enclosure(s) (please identify below):

**REQUEST FOR RECONSIDERATION**

Remarks

## SIGNATURE OF APPLICANT, ATTORNEY, OR AGENT

Firm or Individual name

Harness, Dickey & Pierce, P.C.

Attorney Name

John A. Castellano

Reg. No.

35,094

Signature

Date

March 30, 2005



**PATENT**

**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

APPLICANTS: Ja-Hum KU et al. CONF. NO.: 4261  
SERIAL NO.: 10/612,041 GROUP: 2829  
FILED: July 3, 2003 EXAMINER: Evan T. Pert  
FOR: A METHOD OF FABRICATING A SEMICONDUCTOR DEVICE  
HAVING A SILICON OXIDE LAYER, A METHOD OF  
FABRICATING A SEMICONDUCTOR DEVICE HAVING DUAL  
SPACERS, A METHOD OF FORMING A SILICON OXIDE LAYER  
ON A SUBSTRATE, AND A METHOD OF FORMING DUAL  
SPACERS ON A CONDUCTIVE MATERIAL LAYER

DOCKET NO.: 2557-000153/US

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Customer Service Window  
Randolph Building  
401 Dulany Street  
Alexandria, VA 22314  
Mail Stop **Amendment**

**March 30, 2005**

**REQUEST FOR RECONSIDERATION**

Dear Sir:

In response to the Office Action mailed December 30, 2004, the following remarks are respectfully submitted in connection with the above-identified application.

**Listing of the Claims** begin on page 2 of this Amendment.

**Remarks** begin on page 15 of this Amendment.